# CMP3803A/CMB3803A



#### N-Channel Enhancement Mode Field Effect Transistor

## **General Description**

The 3803A is a N-channel Power MOSFET. It has specifically been designed to minimize input capacitance and gate charge. The device is therefore suitable in advanced high-efficiency switching applications.

#### Features

- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

# **Product Summary**

BVDSS	RDSON	ID
30V	2.7mΩ	180A

## Applications

- LED power controller
- DC-DC & DC-AC converters
- High current, High speed switching
- Solenoid and relay drivers
- Motor control, Audio amplifiers

## TO-220/263 Pin Configuration



Туре	Package	Marking		
CMP3803A	TO-220	CMP3803A		
CMB3803A	TO-263	CMB3803A		

#### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage 30		V	
V <sub>GS</sub>	Gate-Source Voltage	V		
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current,VGS @ 10V	180	A	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current,VGS @ 10V	144	А	
I <sub>DM</sub>	Pulsed Drain Current	540	А	
EAS	Single Pulse Avalanche Energy	322	mJ	
P <sub>D</sub> @T <sub>C</sub> =25°C	Power Dissipation	150	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 175		°C	
TJ	Operating Junction Temperature Range	-55 to 175	°C	

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit	
R <sub>θJA</sub>	Junction-to-Ambient (PCB mount)		62	°C/W	
R <sub>θJC</sub>	Junction-to-Case		0.84	°C/W	



## **N-Channel Enhancement Mode Field Effect Transistor**

#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =40A			2.7	mΩ
Botony		V <sub>GS</sub> =4.5V , I <sub>D</sub> =20A			6.5	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250 u A$	1		3	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = ±20V , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =20A		29		S
R <sub>g</sub>	Gate Resistance	$V_{DS}$ =0V , $V_{GS}$ =0V , f=1MHz		2.7		Ω
Qg	Total Gate Charge	I <sub>D</sub> =15A		57		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =15V		14		nC
Q <sub>gd</sub>	Gate-Drain Charge	V <sub>GS</sub> =10V		24		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =15V		20		
Tr	Rise Time	I <sub>D</sub> =1A		7		20
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =3.3Ω		125		ns
T <sub>f</sub>	Fall Time	V <sub>GS</sub> =10V		16		
Ciss	Input Capacitance			6000		
Coss	Output Capacitance	$V_{DS}$ =25V , $V_{GS}$ =0V , f=1MHz		725		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			538		

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G = V_D = 0V$ , Force Current			180	А
I <sub>SM</sub>	Pulsed Source Current				540	А
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =45A , T <sub>J</sub> =25℃			1.2	V

Note :

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